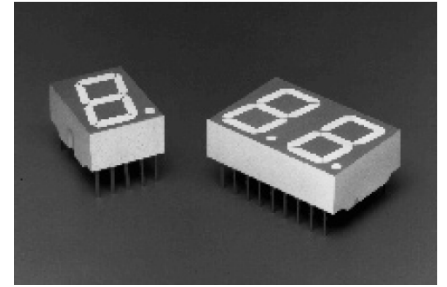# HDSP-550x, HDSP-552x, HDSP-560x, HDSP-562x, HDSP-570x, HDSP-572x, HDSP-H15x Series

14.2-mm (0.56-inch) Seven-Segment Displays

Description

This Broadcom® family of 14.2-mm (0.56-inch) LED seven-segment displays is designed for viewing distances up to 7 meters (23 feet). These devices use an industry-standard size package and pinout. All devices are available as either common anode or common cathode.

Applications

These displays are ideal for most applications. Pin-for-pin equivalent displays are also available in a low current design. The low current displays are ideal for portable applications. For additional information, see the Low-Current Seven-Segment Displays data sheet (AV02-2554EN).

Features

- Industry-standard size
- Industry-standard pinout: 15.24-mm (0.6-in.) DIP leads on 2.54 mm (0.1 in.) centers
- Choice of colors: AllnGaP deep red, AllnGaP red, AllnGaP yellow, AllnGaP green
- Excellent appearance
  - Evenly lighted segments
  - Mitered corners on segments
  - Gray package gives optimum contrast
  - ±50° viewing angle
- Design flexibility
  - Common anode or common cathode
  - Single and dual digits
  - Right-hand decimal point
- Categorized for luminous intensity
  - Yellow and green categorized for color
  - Use of like categories yields a uniform display

Package Drawing
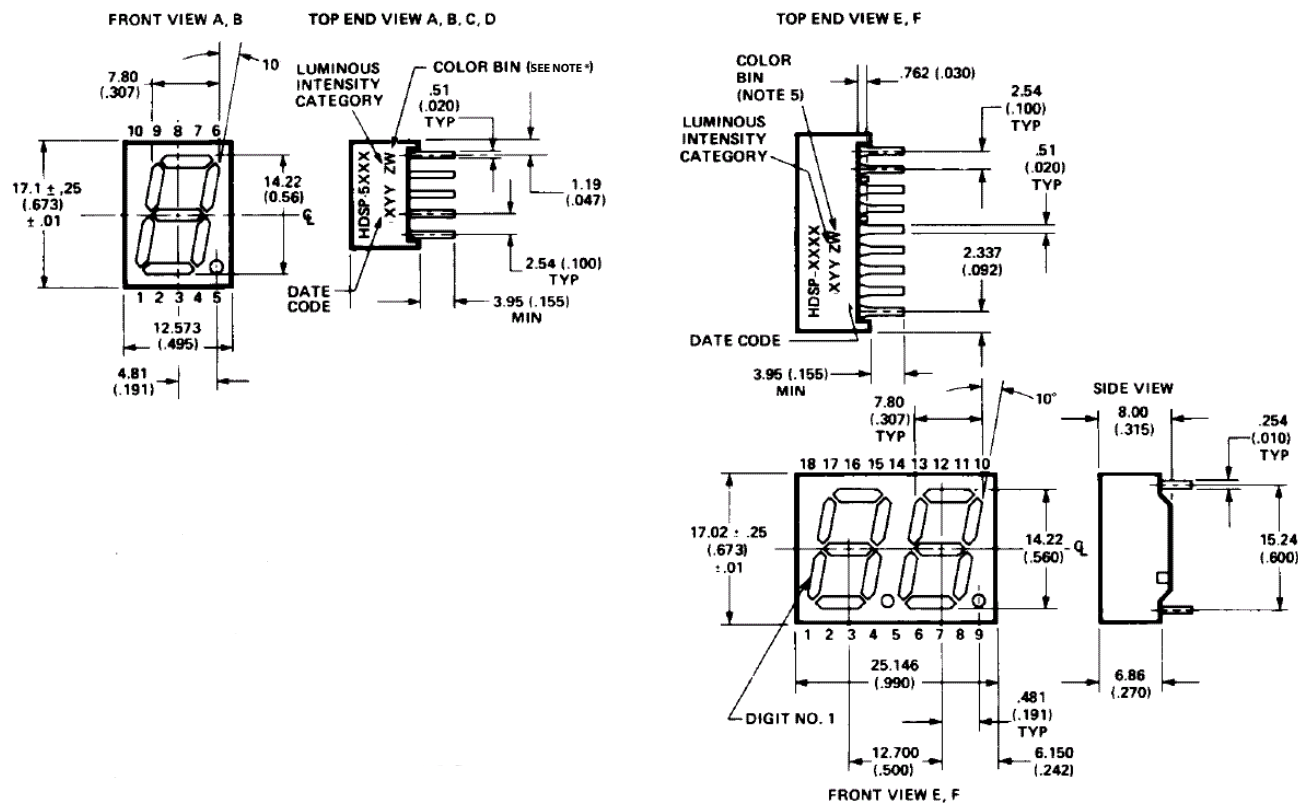
*** FOR HDSP-5600/-5700 SERIES PRODUCTS ONLY.**

NOTE: All dimensions in millimeters (inches). All untoleranced dimensions are for reference only.

Pin	Function			
	A	**B**	**E**	**F**
1	Cathode E	Anode E	E Cathode No. 1	E Anode No. 1
2	Cathode D	Anode D	D Cathode No. 1	D Anode No. 1
3	Anode[a]	Cathode[b]	C Cathode No. 1	C Anode No. 1
4	Cathode C	Anode C	DP Cathode No. 1	DP Anode No. 1
5	Cathode DP	Anode DP	E Cathode No. 2	E Anode No. 2
6	Cathode B	Anode B	D Cathode No. 2	D Anode No. 2
7	Cathode A	Anode A	G Cathode No. 2	G Anode No. 2
8	Anode[a]	Cathode[b]	C Cathode No. 2	C Anode No. 2
9	Cathode F	Anode F	DP Cathode No. 2	DP Anode No. 2
10	Cathode G	Anode G	B Cathode No. 2	B Anode No. 2
11			A Cathode No. 2	A Anode No. 2
12			F Cathode No. 2	F Anode No. 2
13			Digit No. 2 Anode	Digit No. 2 Cathode
14			Digit No. 1 Anode	Digit No. 1 Cathode
15			B Cathode No. 1	B Anode No. 1
16			A Cathode No. 1	A Anode No. 1
17			G Cathode No. 1	G Anode No. 1
18			F Cathode No. 1	F Anode No. 1

a. Redundant anodes.

b. Redundant cathodes.

Internal Circuit Diagram
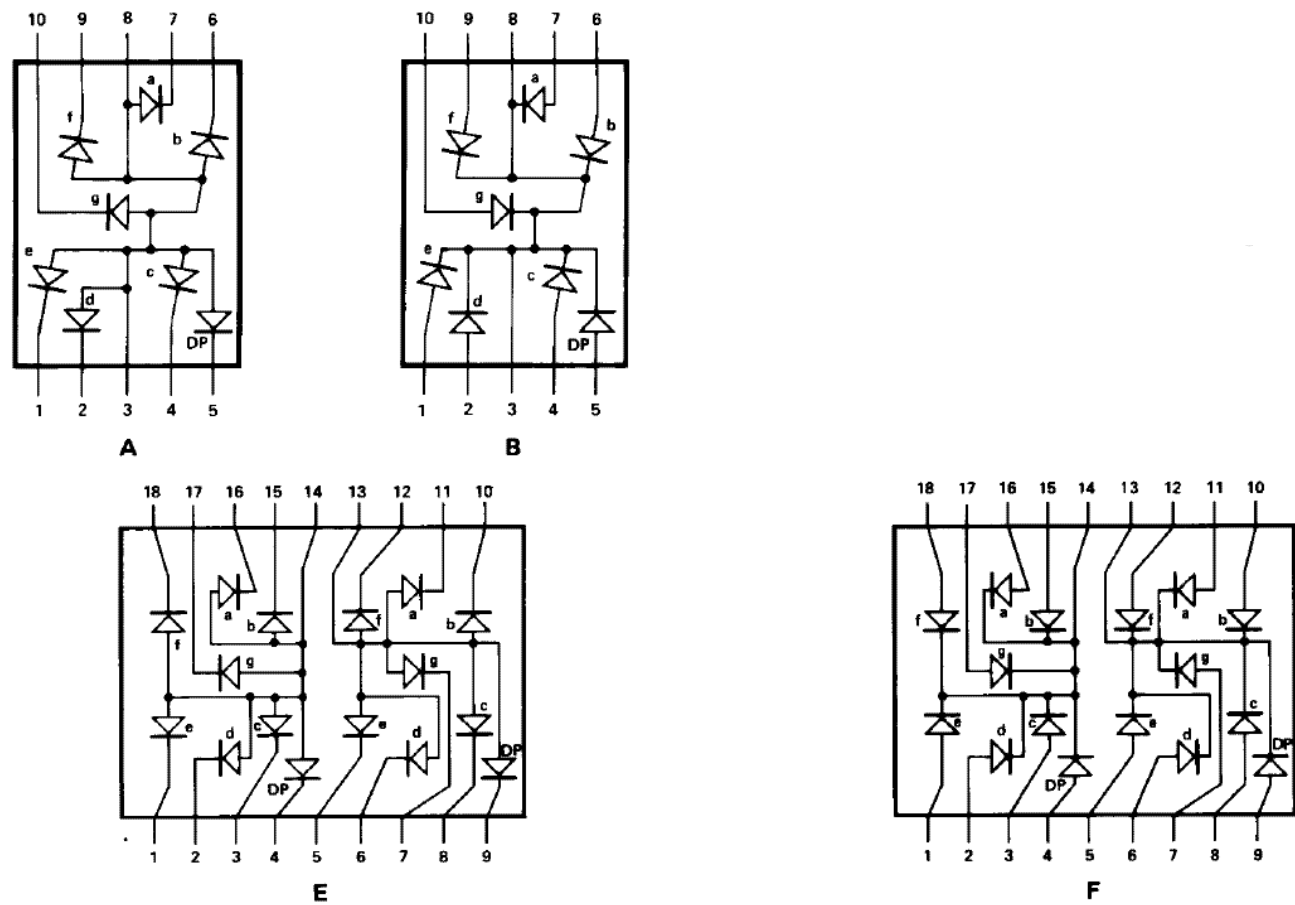
Device Selection Guide

AlInGaP Deep Red HDSP-	AlInGaP Red HDSP-	AlInGaP Yellow HDSP-	AlInGaP Green HDSP-	Description	Pkg Drawing
H151	5501	5701	5601	Common Anode Right-hand Decimal	A
H153	5503	5703	5603	Common Cathode Right-hand Decimal	B
	5521	5721	5621	Two-Digit Common Anode Right-hand Decimal	E
	5523	5723	5623	Two-Digit Common Cathode Right-hand Decimal	F

Absolute Maximum Ratings

Parameter	Deep Red HDSP-H150 Series	Red HDSP-5500 Series	Yellow HDSP-5700 Series	Green HDSP-5600 Series	Unit
Power Dissipation per Segment or DP	100	75	50	75	mW
Peak Forward Current per Segment or DP[a]	90	90	60	90	mA
DC Forward Current per Segment or DP[b]	40	30	20	30	mA
Operating Temperature Range	−20 to +100	−40 to +100			°C
Storage Temperature Range	−55 to +100				°C
Reverse Voltage per Segment or DP[c]	3.0				V
Wave Soldering Temperature for 3s (1.60 mm [0.063 in.] below body)	250				°C

a. Duty factor = 10%, frequency = 1 kHz, T_A = 25°C.

b. Derate linearly as shown in Figure 4 (deep red), Figure 8 (red), Figure 12 (yellow), and Figure 16 (green).

c. Reverse voltage is for LED testing purposes and is not recommended to be used as an application condition.
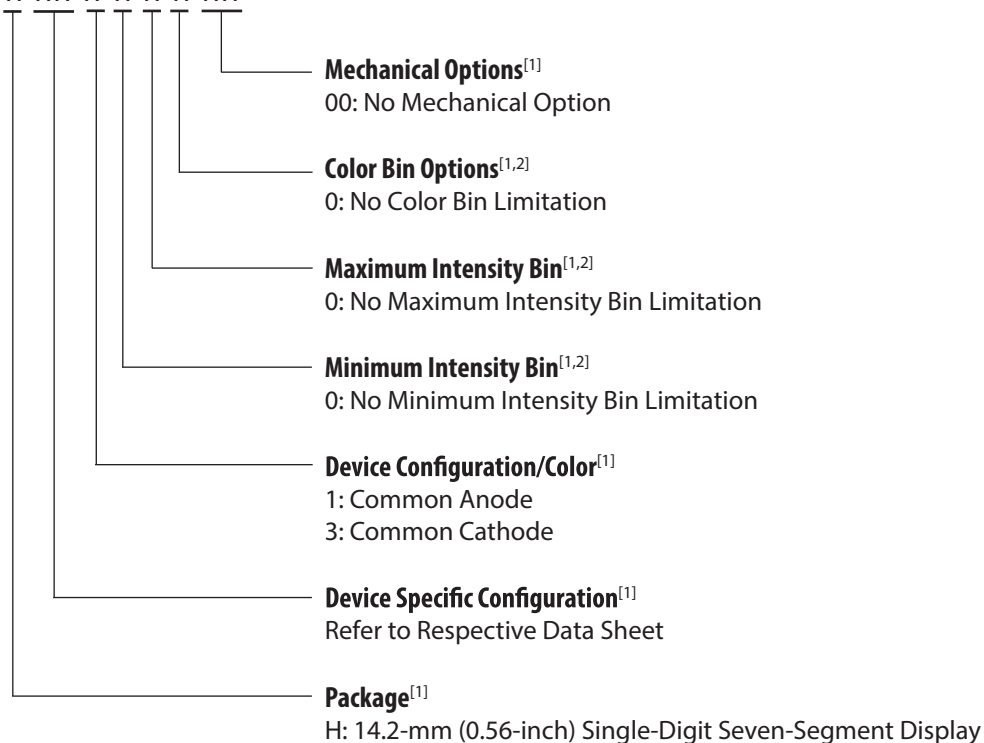
Electrical/Optical Characteristics (T_A = 25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Condition
Deep Red, Device Series HDSP-H15X						
Luminous Intensity/Segment (Digital Average)[a, b]	I_V	9.1	20	—	mcd	I_F = 20 mA
Forward Voltage/Segment or DP[c]	V_F	—	2.1	2.5	V	I_F = 20 mA
Peak Wavelength	λ_p	—	656	—	nm	
Dominant Wavelength[d]	λ_d	—	639	—	nm	
Reverse Voltage/Segment or DP[e]	V_R	3.0	—	—	V	I_R = 100 µA
Red, Device Series HDSP-55XX						
Luminous Intensity/Segment (Digital Average)[a, b]	I_V	2.05	8.50	—	mcd	I_F = 10 mA
Forward Voltage/Segment or DP[c]	V_F	—	2.05	2.5	V	I_F = 20 mA
Peak Wavelength	λ_p	—	631	—	nm	
Dominant Wavelength[d]	λ_d	—	622	—	nm	
Reverse Voltage/Segment or DP[e]	V_R	3.0	—	—	V	I_R = 100 µA
Yellow, Device Series HDSP-57XX						
Luminous Intensity/Segment (Digital Average)[a, b]	I_V	0.6	4.0	—	mcd	I_F = 10 mA
Forward Voltage/Segment or DP[c]	V_F	—	2.0	2.5	V	I_F = 20 mA
Peak Wavelength	λ_p	—	591	—	nm	
Dominant Wavelength[d]	λ_d	581.5	587	592.5	nm	
Reverse Voltage/Segment or DP[e]	V_R	3.0	—	—	V	I_R = 100 µA

Parameter	Symbol	Min.	Typ.	Max.	Unit	Test Condition
Green, Device Series HDSP-56XX						
Luminous Intensity/Segment (Digital Average)[a, b]	I_V	2.05	8.0	—	mcd	I_F = 10 mA
Forward Voltage/Segment or DP[c]	V_F	—	2.1	2.5	V	I_F = 10 mA
Peak Wavelength	λ_p	—	572	—	nm	
Dominant Wavelength[d]	λ_d	—	571	577	nm	
Reverse Voltage/Segment or DP[e]	V_R	3.0	—	—	V	I_R = 100 µA

a. The luminous intensity, I_V, is measured at the mechanical axis of the package.

b. The optical axis is closely aligned with the mechanical axis of the package.

c. Forward voltage tolerance is ±0.1V.

d. The dominant wavelength, λ_d, is derived from the CIE Chromaticity Diagram and represents the color of the device.

e. Typical specification for reference only. Do not exceed absolute maximum ratings, and long-term reverse bias is not recommended.

Part Numbering System

```
5082 -X XX X-X X X XX
HDSP-X XX X-X X X XX
```

Mechanical Options[1]
00: No Mechanical Option

Color Bin Options[1,2]
0: No Color Bin Limitation

Maximum Intensity Bin[1,2]
0: No Maximum Intensity Bin Limitation

Minimum Intensity Bin[1,2]
0: No Minimum Intensity Bin Limitation

Device Configuration/Color[1]
1: Common Anode
3: Common Cathode

Device Specific Configuration[1]
Refer to Respective Data Sheet

Package[1]
H: 14.2-mm (0.56-inch) Single-Digit Seven-Segment Display

1. For codes not listed in the figure, refer to the respective data sheet or contact your nearest Broadcom representative for details.

2. Bin options refer to shippable bins for a part number. Color and Intensity Bins are typically restricted to 1 bin per tube (exceptions may apply). Refer to respective data sheet for specific bin limit information.

Intensity Bin Limits (mcd)

Deep Red
HDSP-H15x

IV Bin Category	Min.	Max.
K	9.20	16.90
L	13.80	25.30
M	20.70	38.00
N	31.10	56.90
O	46.60	85.40

Red
HDSP-550x/552x

IV Bin Category	Min.	Max.
G	2.05	3.76
H	3.08	5.64
I	4.62	8.64
J	6.93	12.70
K	10.39	19.04
L	15.58	28.48
M	23.30	42.56

Yellow
HDSP-570x/572x

IV Bin Category	Min.	Max.
D	0.61	1.11
E	0.91	1.67
F	1.37	2.51
G	2.05	3.76
H	3.08	5.64
I	4.62	8.64
J	6.93	12.70
K	10.39	19.04
L	15.58	28.57
M	23.37	42.86

Green
HDSP-560x/562x

IV Bin Category	Min.	Max.
G	2.05	3.76
H	3.08	5.64
I	4.61	8.46
J	6.92	12.69
K	10.39	19.04
L	15.58	28.57

Color Categories

Color	Bin	Dominant Wavelength (nm)	
		Min.	Max.
Yellow	1	581.50	585.00
	2	584.00	587.50
	3	586.50	590.00
	4	589.00	592.50
Green	2	573.00	577.00
	3	570.00	574.00
	4	567.00	571.00
	5	564.00	568.00

NOTE: All categories are established for classification of products. Products may not be available in all categories. Contact your Broadcom representatives for further clarification or information.

Deep Red Graphs

Figure 1: Relative Intensity vs. Wavelength
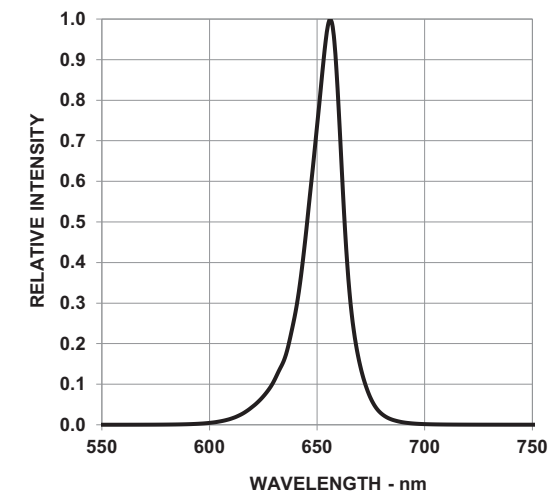
Figure 2: Forward Current vs. Forward Voltage
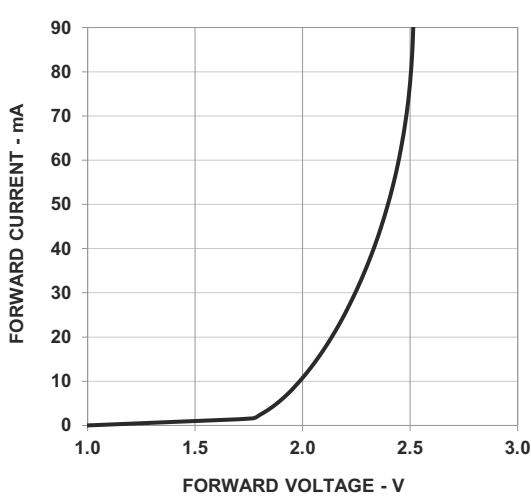
Figure 3: Relative Luminous Intensity vs. Forward Current
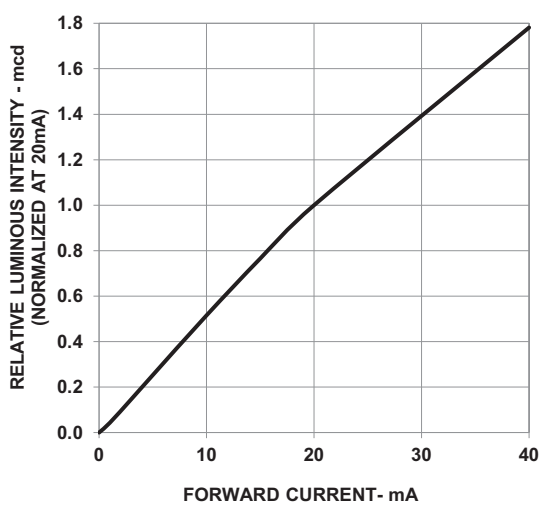
Figure 4: Maximum Forward Current vs. Ambient Temperature
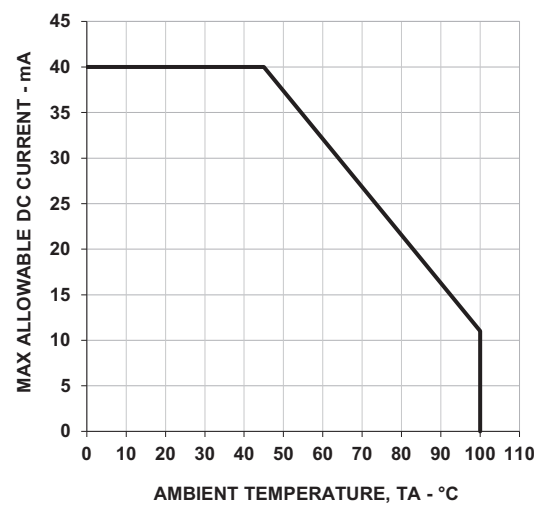
Red Graphs

Figure 5: Relative Intensity vs. Wavelength
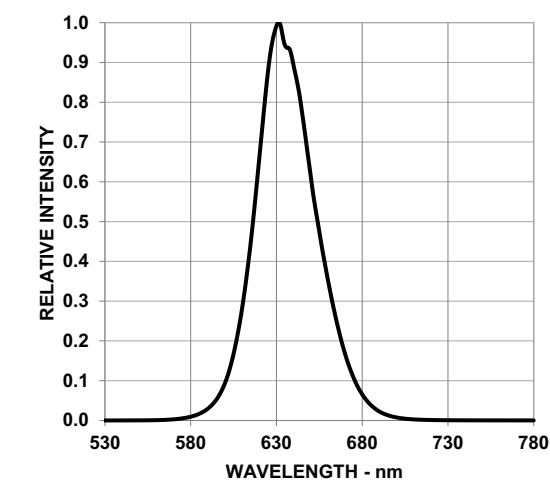
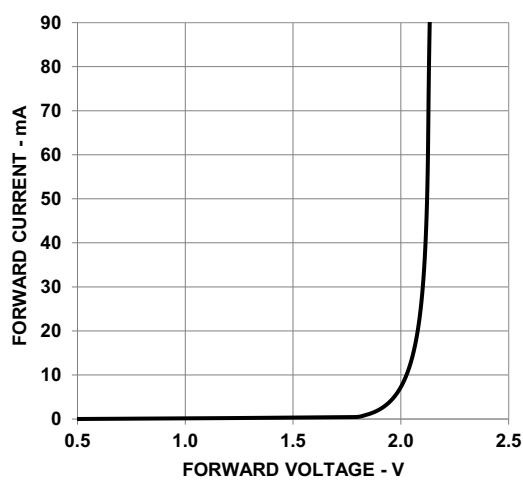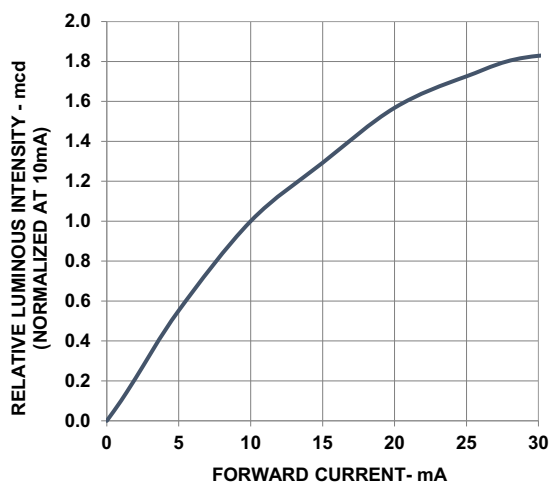**Figure 6: Forward Current vs. Forward Voltage**

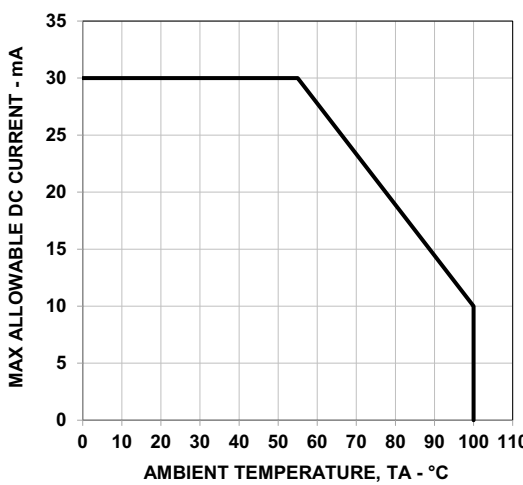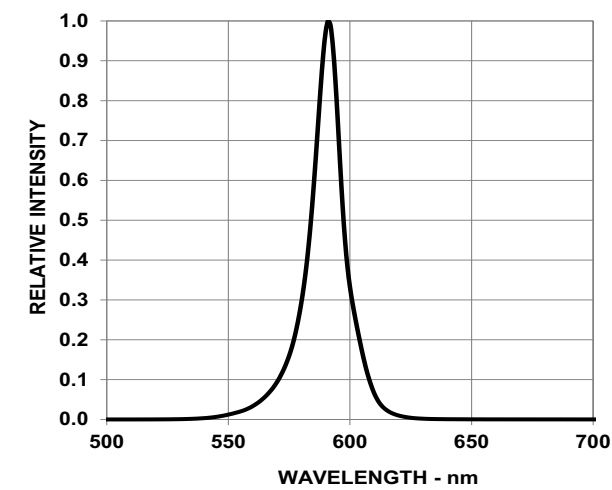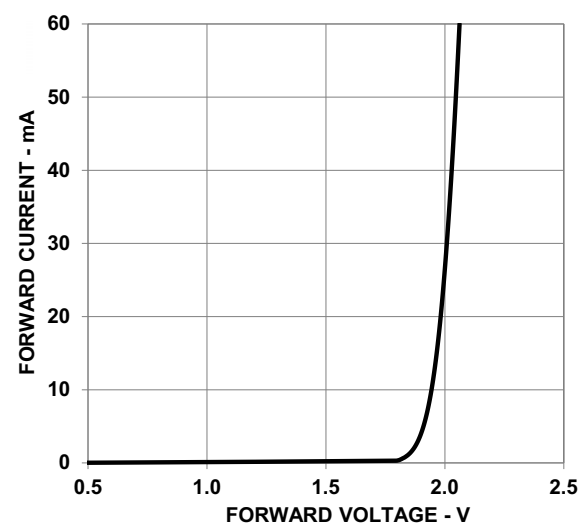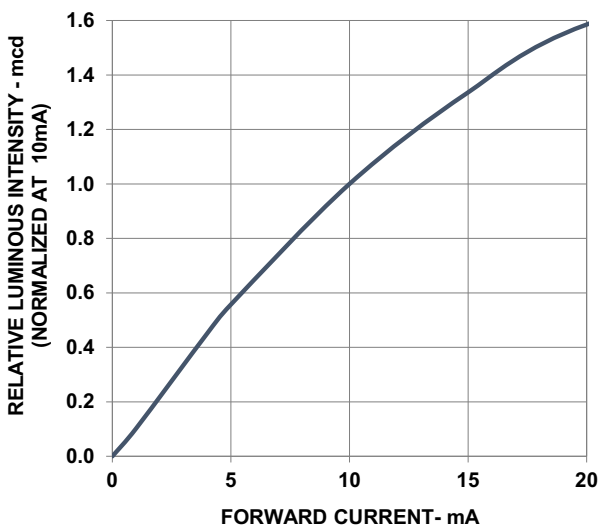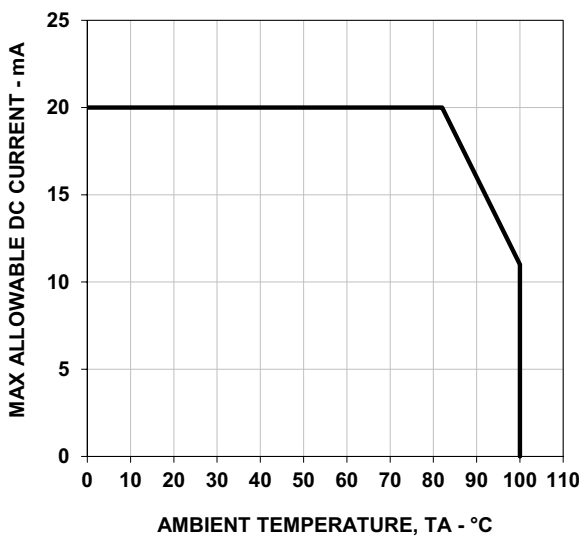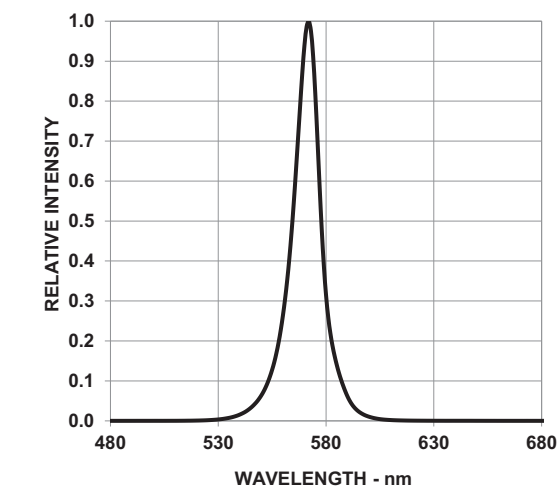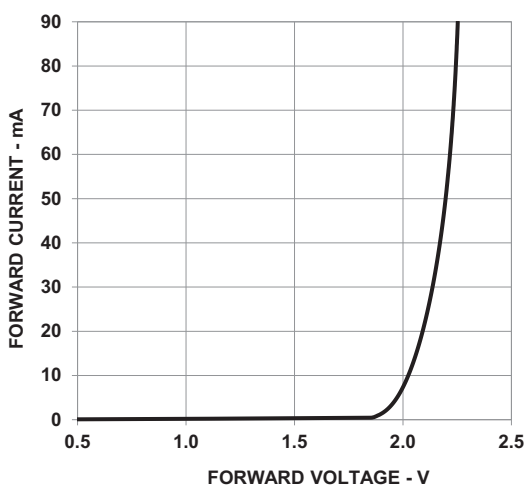**Figure 7: Relative Luminous Intensity vs. DC Forward Current**

Figure 8: Maximum Forward Current vs. Ambient Temperature

Yellow Graphs

Figure 9: Relative Intensity vs. Wavelength

Figure 10: Forward Current vs. Forward Voltage

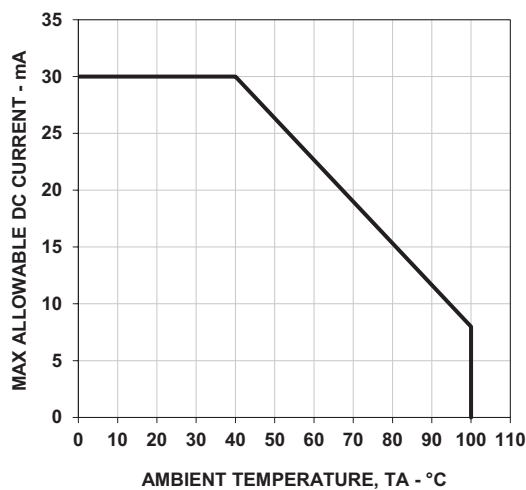**Figure 11: Relative Luminous Intensity vs. Forward Current**

Figure 12: Maximum Forward Current vs. Ambient Temperature

Green Graphs

Figure 13: Relative Intensity vs. Wavelength

Figure 14: Forward Current vs. Forward Voltage

Figure 15: Relative Luminous Intensity vs. DC Forward Current
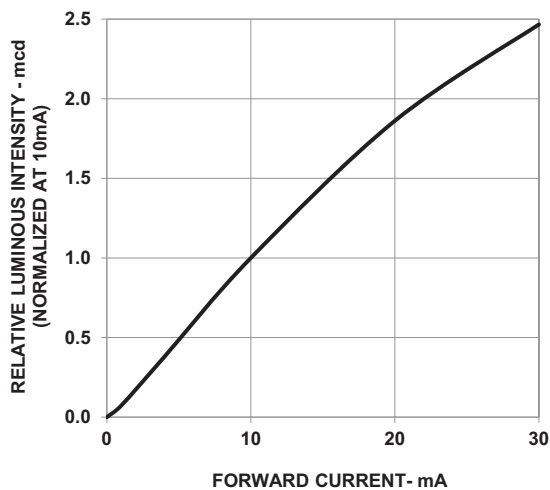
Figure 16: Maximum Forward Current vs. Ambient Temperature

Precautionary Notes

Soldering and Handling Precautions

- Set and maintain the wave soldering parameters according to the recommended temperature and dwell time. Perform daily checks on the profile to ensure that it is always conforming to the recommended conditions. Exceeding these conditions will over-stress the LEDs and cause premature failures.

- Use only bottom preheaters to reduce thermal stress experienced by the LEDs.

- Recalibrate the soldering profile before loading a new type of a PCB. PCBs with different sizes and designs (component density) will have different heat capacities and might cause a change in temperature experienced by the PCB if the same wave soldering setting is used.

- Do not perform wave soldering more than once.

- Any alignment fixture used during wave soldering must be loosely fitted and must not apply stress on the LEDs. Use non-metal material because it will absorb less heat during the wave soldering process.

- At elevated temperatures, the LEDs are more susceptible to mechanical stress. Allow the PCB to be sufficiently cooled to room temperature before handling. Do not apply stress to the LED when it is hot.

- Use wave soldering to solder the LED. Use hand soldering only for rework or touch up if unavoidable, but it must be strictly controlled to following conditions:
  - Soldering iron tip temperature = 315°C maximum.
  - Soldering duration = 2 seconds maximum.
  - Number of cycles = 1 only.
  - Power of soldering iron = 50W maximum.

- For ESD-sensitive devices, apply proper ESD precautions at the soldering station. Use only an ESD-safe soldering iron.

- Do not touch the LED package body with the soldering iron except for the soldering terminals because it may cause damage to the LED.

- Confirm beforehand whether the functionality and performance of the LED is affected by soldering with hand soldering.

- Keep the heat source at least 1.6 mm away from the LED body during soldering.

- Design an appropriate hole size to avoid problems during insertion.

- Cleaning agents from the ketone family (acetone, methyl ethylketone, and so on) and from the chlorinated hydrocarbon family (methylene chloride, trichloroethylene, carbon tetrachloride, and so on) are not recommended for cleaning the LED displays. All of these various solvents attack or dissolve the encapsulating epoxies used to form the package of plastic LED parts.

- For the purpose of cleaning, wash with DI water only. The cleaning process should take place at room temperature only. Clear any water or moisture from the LED display immediately after washing.

- Use of *No clean* solder paste is recommended for soldering.

Figure 17: Recommended Wave Soldering Profile
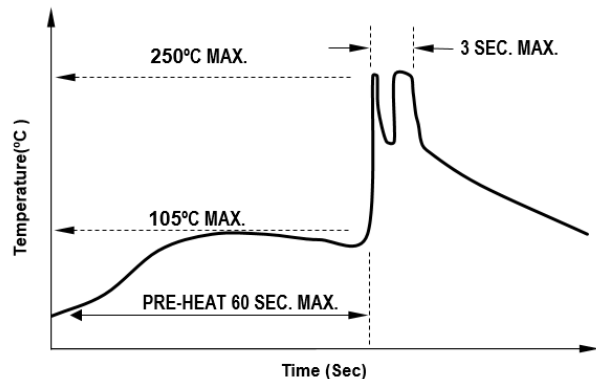
NOTE: Figure 17 refers to measurements with thermocouple mounted at the bottom of the PCB.

Application Precautions

- The drive current of the LED must not exceed the maximum allowable limit across temperatures as stated in the data sheet. Constant current driving is recommended to ensure consistent performance.

- Circuit design must cater to the whole range of forward voltage (V_F) of the LEDs to ensure the intended drive current can always be achieved.

- The LED exhibits slightly different characteristics at different drive currents, which may result in a larger variation of performance (such as intensity, wavelength, and forward voltage). Set the application current as close as possible to the test current to minimize these variations.

- The LED is not intended for reverse bias. Use other appropriate components for such purposes. When driving the LED in matrix form, ensure that the reverse bias voltage does not exceed the allowable limit of the LED.

- Avoid rapid change in ambient temperatures, especially in high-humidity environments, because they cause condensation on the LED.
- If the LED is intended to be used in a harsh or outdoor environment, protect the LED against damages caused by rain, water, dust, oil, corrosive gases, external mechanical stresses, and so on.

Eye Safety Precautions

LEDs may pose optical hazards when in operation. Do not look directly at operating LEDs because it might be harmful to the eyes. For safety reasons, use appropriate shielding or personal protective equipment.

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Lead (Pb) Free
RoHS Compliant